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# GOMACTech-22

“Enabling Distributed Capabilities:  
Microelectronics Thriving in the Face of Change”  
Hyatt Regency, Miami FL  
21 – 24 March 2022

## Second Call for Papers

GOMACTech was established primarily to report on developments in microcircuit technologies and applications for government systems. Established in 1968, the conference has focused on advances in systems and technologies being developed by the Department of Defense and other government agencies, and has been used to announce major government microelectronics initiatives and provides a forum for government reviews. GOMACTech-22 features plenary sessions addressing the theme “Enabling Distributed Capabilities: Microelectronics Thriving in the Face of Change,” as well as a technical program describing the latest technological advances in the field, including trustworthy and cyber-secure components/technologies, Electro-Optical components, RF components, Micro-Nano electronics, electronics integration, electronics materials, emerging neuromorphic electronics, quantum information/sensing technologies and technologies beyond Moore’s law, advances in wide and ultrawide-bandgap materials and device development, and novel power electronics. Abstracts are solicited in the topic areas listed below. Detailed descriptions of the technical topic areas can be found [here](#). GOMACTech is the premier forum for reporting on government funded microcircuit research and other research efforts that focus on the technology needs of government systems. It is an unclassified, export controlled event. All registrants must provide proof of U.S. citizenship or permanent residence status and sign a non-disclosure statement prior to being permitted entry into the conference. Authors whose abstract is accepted (oral and poster presentations) are expected to produce a paper for the conference proceedings.

### Technical Topic Areas

Radiation Hardened Technologies, Designs & Systems

Trusted, Assured and Cyber-Secure Microelectronics

RF Technologies, Components and Systems

EO/IR Technologies, Components and Systems

High Performance Digital and Mixed Signal Technologies

Photonic Technologies, Components and Systems

Power Electronics & Emerging Power Technologies

Packaging, Integration, Thermal and Control Technologies

Emerging Technologies (Quantum, Neuromorphic, Flexible Electronics, IC’s beyond Moore’s law...)

Advanced Materials and Processes

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| • Electronic Abstracts Due <a href="http://www.gomactech.net/">http://www.gomactech.net/</a> | September 10, 2021 |
| • Author Notification of Acceptance  | November 5, 2021   |
| • Final Paper Due  | January 10, 2022   |

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